

X-CON BRAND

CONDUCTIVE POLYMER ALUMINUM SOLID CAPACITORS

PRODUCT SPECIFICATION 規格書

CUSTOMER: DATE:

(客戶): 志盛翔 (日期): 2016-04-28

CATEGORY (品名) : CONDUCTIVE POLYMER ALUMINUM

SOLID CAPACITORS

DESCRIPTION (型号) : ULR 16V100 μ F (φ6.3x8)

VERSION (版本) : 01

Customer P/N : /

SUPPLIER : /

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PREPARED (拟定)	CHECKED (审核)		
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ULR SERIES						ECORDS	
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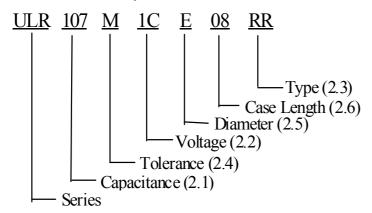
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1. Application

This specification applies to conductive polymer aluminum solid capacitors used in electronic equipment.

2. Part Number System



2.1 <u>Capacitance code</u>

Code	107
Capacitance (µ F)	100

2.2 Rated voltage code

Code	1C
Voltage (W.V.)	16

2.3 <u>Type</u>

Code	RR
Type	Bulk

2.4 <u>Capacitance tolerance</u>

"M" stands for $-20\% \sim +20\%$

2.5 Diameter

Code	E
Diameter	6.3

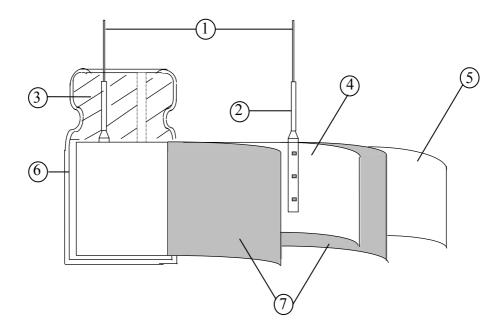
2.6 <u>Case length</u> 08=8mm

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3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be formed and carbonized, impregnated with polymer and polymerized, then will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber.



No	Component	Material
1	Lead Line	Tinned Copper Line or CP Line(Pb Free)
2	Terminal	Aluminum
3	Sealing Material	Rubber
4	Al-Foil (+)	Aluminum
5	Al-Foil (-)	Aluminum
6	Case	Aluminum
7	Electrolyte paper	Manila Hemp

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature: 15°C to 35°C Relative humidity : 45% to 75% Air Pressure : 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:

Ambient temperature: $20^{\circ}\text{C} \pm 2^{\circ}\text{C}$ Relative humidity : 60% to 70%Air Pressure : 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage is -55°C to 105°C.

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	ITEM	PERFORMANCE
4.1	Rated voltage (WV) Surge voltage (SV)	WV (V.DC) 16 SV (V.DC) 18.4
4.2	Nominal capacitance (Tolerance)	Condition> Measuring Frequency : 120Hz±12Hz Measuring Voltage : Not more than 0.5Vrms Measuring Temperature : 20±2°C Criteria> Shall be within the specified capacitance tolerance.
4.3	Leakage current	Condition> After DC Voltage is applied to capacitors through the series protective resistor (1k $\Omega \pm 10\Omega$) so that terminal voltage may reach the rated voltage .The leakage current when measured after 2 minutes shall not exceed the values of the following equation. In case leakage current value exceed the value shown in Table 3 , remeasure after voltage treatment that applies the rated voltage shown in 4.1 for 120minutes at 105 °C Criteria> See Table 3
4.4	tan δ	<pre><condition> See 4.2, for measuring frequency, voltage and temperature. </condition></pre> <pre><criteria></criteria></pre> <pre>Working voltage (v) 16 $\tan \delta$ (max.) 0.10</pre>
4.5	ESR	Condition> Measuring frequency : 100kHz to 300kHz; Measuring temperature:20±2°C Measuring point : 2mm max from the surface of a sealing resin on the lead wire Criteria> (20°C)Less than the initial limit(See Table 3).

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		STEP	Temperature(°C)	Item	Characteristics	
		1	20±2	Measure: Capacitance tanδ Impedance		
		2	-55+3	Z-55°C / 20°C	≤1.25	
	Temperature	3	Keep at 15 to 35°C for 15 minutes or more			
4.6	characteristic	4	105 ± 2	Z105℃ / 20℃	≤1.25	
				∆ C/C 20°C	Within \pm 5% of step1	
		5	20±2	tanδ	Less than or equal to the value of item 4.4	
		The Co	dition> apacitor is stored at a tere for 2000 +48/0 hours.			
		<crit< td=""><td></td><td>formance</td><td></td></crit<>		formance		
		tan δ	Les	hin $\pm 20\%$ of initial c s than or equal to 1.5 14.4	times of the value of	
	Load	ESR	Les		times of the value of	
4.7	life	Leak	age current Les	Less than or equal to the value of item 4.3		
	test	Appe	earance No	Notable changes shall not be found.		

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		seconds in every 5 minute	d the surge voltage through $1k\Omega$ resistor in series for 30 ± 5 es 30 s at $15\sim35^{\circ}C$. Procedure shall be repeated 1000 times. Eleft under normal humidity for 1-2hours before measurement.
	Surge	Item	Performance
4.8	test	Capacitance Change	Within $\pm 20\%$ of initial capacitance
		tan δ	Less than or equal to 1.5 times of the value of item 4.4
		ESR	Less than or equal to 1.5 times of the value of item 4.5
		Leakage current	Less than or equal to the value of item 4.3 nulates over voltage at abnormal situation, and not be
		<condition> Humidity Test:</condition>	
		-	xposed for 1000 ± 48 hours in an atmosphere of $90 \sim 95\%$ RH at istic change shall meet the following requirement. Performance
		Capacitance Change	Within $\pm 20\%$ of initial capacitance
		tan δ	Less than or equal to 1.5 times of the value of item 4.4
	Damp	ESR	Less than or equal to 1.5 times of the value of item 4.5
4.9	heat test	Leakage current	Less than or equal to the value of item 4.3
	test	Appearance	Notable changes shall not be found.

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	1					
4.10	Maximum permissible (ripple current)	Condition> The maximum perm At 100kHz and can Table 3 The combined value rated voltage and sh Frequency Multiplie Frequency Coefficient	be applied at e of D.C volta nall not revers	maximum open ge and the peak	rating temperatur	re see
		Applied voltage: with Cycle number: 5 cycl Test diagram: Fig.1		30±3 min 3 min 1cyc	Roo 30±3 min n or less	5±2°C m temperature ±3°C
		Performance: The ca	pacitors shall Performar		ving specification	n after 5 cycles.
4.11	Rapid change				canacitance	
	oi temperature					
		Leakage current		or equal to the	value of item 4.3	(after
4.11	of temperature	Capacitance change tan δ Leakage current	Less than Less than		ie of item 4.4	(after

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4.12	Lead strength	in a direction away from the Lead wire diame $0.5 < d \le 0.8$ b) Lead bending When the capacitor is place	the body for $10\pm$	erminal in the axial direction and acting 1 s. Load force (N) 10
4.12	Lead strength	in a direction away from the Lead wire diame $0.5 < d \le 0.8$ b) Lead bending When the capacitor is place	the body for $10\pm$	Load force (N)
4.12	Lead strength	Lead wire diame $0.5 < d \le 0.8$ b) Lead bending When the capacitor is place		Load force (N)
4.12	Lead strength	$0.5 \le d \le 0.8$ b) Lead bending When the capacitor is place	eter (mm)	` ′
4.12	Lead strength	b) Lead bending When the capacitor is place		10
4.12	Lead strength	When the capacitor is place		
4.12	Lead strength	When the capacitor is place		
4.12	Lead strength		ed in a vertical n	osition and the weight specified in the
4.12	Lead strength	table above is applied to be		the capacitor is slowly rotated 90° to a
				ertical position thus completing bends
		for 2~3 seconds.		
		The additional bends are n		
		Lead wire diamete	er (mm)	Load force (N)
		$0.5 < d \le 0.8$		5
				the following value after a) or b) test.
		Item	Performance	
		Leakage current Outward Appearance		r equal to the value of item4.3 and slack of lead terminals
		Outward Appearance	1 No cutting a	ind stack of feat terminals
4.13	Resistance to vibration	capacitance when the value is n	Fig2 e shall not show neasured within 1.5mm)	

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	<u> </u>		
4.14	Solderability	Solder : Sn-3 Soldering temperature: 245± Immersing time : 3±0. Immersing depth : 1.5~ Flux : App	
4.15	Resistance to soldering heat	A) Solder bath method Lead terminals of a capacitor a 1.6±0.5mm. It will dip into the Then it will be immersed at the st Solder : Sn Soldering temperature : 260 Immersing time : 10: Heat protector: t=1.6mm glass B) Soldering iron method Bit temperature : 400 Application time : 3+1 Heat protector: t=1.6mm For both methods, after the capace measured: Item	±10°C /-0 s glass –epoxy board itor at thermal stability, the following items shall be Performance Within ±5% of initial capacitance Less than or equal to the value of item 4.4 Less than or equal to the value of item 4.5 Less than or equal to the value of item 4.3 (after voltage treatment)
		Appearance	Notable changes shall not be found.

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5. Product Marking

Marking Sample:

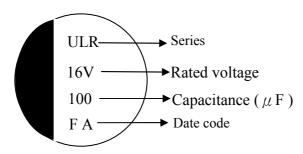


Table 1				
Code	С	D	Е	F
Year	2013	2014	2015	2016

— Manufactured week: see Table 2

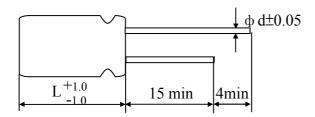
Table 2						- Manu	facture	d year:	see Tab	le 1	
Week	1	2	3	4	5	6	7	8	9	10	11
Code	A	В	C	D	Е	F	G	Н	I	J	K
Week	12	13	14	15	16	17	18	19	20	21	22
Code	L	M	N	О	P	Q	R	S	Т	U	V
Week	23	24	25	26	27	28	29	30	31	32	33
Code	W	X	Y	Z	<u>A</u>	<u>B</u>	<u>C</u>	<u>D</u>	<u>E</u>	<u>F</u>	<u>G</u>
Week	34	35	36	37	38	39	40	41	42	43	44
Code	<u>H</u>	<u>I</u>	<u>J</u>	<u>K</u>	<u>L</u>	<u>M</u>	<u>N</u>	<u>O</u>	<u>P</u>	Q	<u>R</u>
Week	45	46	47	48	49	50	51	52			
Code	<u>S</u>	<u>T</u>	<u>U</u>	<u>V</u>	W	<u>X</u>	<u>Y</u>	<u>Z</u>			

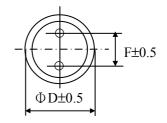
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6. Product Dimensions, Impedance & Maximum Permissible Ripple Current Unit: mm





фD	6.3
L	8
F	2.5
Фd	0.6

Table 3

Voltage (V)	(µ F)	(D×L, mm)	ripple current at 105°C 100kHz (mA rms)	to300kHz (mΩ)	(µ A) 2min
16	100	6.3X8	2820	(mΩ)	320

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7. Application Guideline:

X-CON Solid Aluminum Electrolytic Capacitor should be used compliance with the following guidelines

7-1Circuit design

Prohibited Circuits for use

Do not use the capacitors with the following circuits.

- 1) Time constant circuits
- 2) Coupling circuits
- 3) Circuits which are greatly affected by leakage current
- 4) High impedance voltage retention circuits.

7-2. Voltage

1) Over voltage

The application of over-voltage and reverse voltage below can cause increases in leakage current and short circuits. Applied voltage, refers to the voltage value including the peak value of the transitional instantaneous voltage and the peak Value of ripple voltage, not just steady line voltage. Design your circuit so that the peak voltage does not exceed the stipulated voltage.

Over voltage exceeding the rated voltage may not be applied even for an instant as it may cause a short circuit.

- 2) Applied voltage
- ① Sum of the DC voltage value and the ripple voltage peak values must not exceed the rated voltage.
- ② When DC voltage is low, negative ripple voltage peak value must not become a reverse voltage that exceeds 10% of The rated voltage.
- ③ Use the X-CON within 20% of the rated voltage for applications which may cause the reverse voltage during the Transient phenomena when the power is tumid off or the source is switched.

7-3 Sudden charge and discharge restricted

Sudden charge and discharge may result in short circuit's large leakage current. Therefore, a protection circuits are recommended to design in when on of the following condition is expected.

- 1) The rush current exceeds 10A
- 2) The rush current exceeds 10 times of allowable ripple current of X-CON.

A protection resistor (1K Ω) must be inserted to the circuit during the charge and discharge when measuring the leakage Current.

7-4 Ripple current

Use the capacitors within the stipulated permitted ripple current. When excessive ripple current is applied to the capacitor, It causes increases in leakage current and short circuits due to self- heating. Even when using the capacitor under the Permissible ripple current, reverse voltage may occur if the DC bias voltage is low.

7-5 Leakage current

There is a risk of leakage current characteristics increasing even if the following use environments are within the stipulated range However, even if leakage current increases once, it has the characteristic that leakage current becomes small in most cases after voltage is applied due to its self-correction mechanism.

7-6 Failure rate

The main failure mode of X-CON is open mode primarily caused by electrostatic capacity drop at high temperature (i.e.wear out failure), besides random short circuit mode failures primarily caused by over voltage occurs as minor one. The time it takes to reach the failures mode can be extended by using the X-CON with reduced ambient temperature, ripple current and applied voltage.

7-7 Capacitor insulation

- 1) Insulation in the marking sleeve is not guaranteed. Be aware that the space between the case and the negative electrode Terminal is not insulated and has some resistance.
- 2) Be sure to completely separate the case, negative lead terminal, and positive lead terminal and PCB patterns with each other.

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7-8 Precautions for using capacitors

- X-CON capacitors should not be used in the following environments.
- 1) Environments where the capacitor is subject to direct contact with salt water or oil can directly fall on it.
- 2) Environments where capacitors are exposed to direct sunlight.
- 3) High temperature (Avoid locating heat generating components around the X-CON and on the underside of the PCB), or humid environments where condensation can form on the surface of the capacitor.
 - 4) Environments where the capacitor is in contact with chemically active gases.
 - 5) Acid or alkaline environments.
 - 6) Environment subject to high-frequency induction.
 - 7) Environment subject to excessive vibration and shock.

8. Mounting Precautions

Mounting phase	Things to note before mounting	Disposal
	1) Used X-CON capacitors	Not reused
	2) LC-increased X-CON capacitors	Apply them with rated voltage in series with 1K Ω
	after long storage	resistance for 1 hour at the range between 60 and 70°C
	3) X-CON capacitors dropped to the	Not reused
	floor	
Before mounting	4) Precautions on polar, capacitance	Products without remarkable polar, capacitance and rated
Defore mounting	and rated voltage	voltage shouldn't be available
	5) Precautions on the pitch between	The products can be used only when said pitch is matched
	lead terminal and PCB	
	6) Precautions on the stress that lead	The products can be used for production only when lead
	terminal and body of X-CON	terminal and body are not subject stress.
	capacitors enduring in mounting	
	1) Soldering with a soldering iron	Both temperature and duration in mounting should meet
		the requirements of out-going SPEC; no stress should be
		allowed to occur in mounting; Don't let the tip of the
Mounting	2) Flore coldesing	soldering iron touch the X-CON itself. X-CON capacitor body should be prohibited to submerge
Mounting	2) Flow soldering	in melted solder; both temperature and duration in
		mounting should meet the requirements of out-going
		SPEC; The rosin is not allowed to adhere to any where
		other than lead terminal.
	1) Precautions on mounting status	Do not tilt, bend twists X-CON; Do not allow other matter
		touch X-CON.
	2) Washing the PCB (available	Used immersion or ultrasonic waves to clean for a total of
	cleaning agent 1)high quality	less than 5 minutes and the temperature be less than 60°C;
After mounting	alcohol-based cleaning fluid such as	The conductivity, PH, specific gravity and water cleaning,
	st-100s、750L,750M;2) Detergents	X-CON products should be dried with hot air (less than
	including substitute freon such as	the maximum operating temperature).
	AK-225AES and IPA)	

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9. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances				
	Cadmium and cadmium compounds				
Heavy metals	Lead and lead compounds				
	Mercury and mercury compounds				
	Hexavalent chromium compounds				
	Polychlorinated biphenyls (PCB)				
Chloinated	Polychlorinated naphthalenes (PCN)				
organic	Polychlorinated terphenyls (PCT)				
compounds	Short-chain chlorinated paraffins(SCCP)				
	Other chlorinated organic compounds				
D : 1	Polybrominated biphenyls (PBB)				
Brominated .	Polybrominated diphenylethers(PBDE) (including				
organic	decabromodiphenyl ether[DecaBDE])				
compounds	Other brominated organic compounds				
Tributyltin comp	ounds(TBT)				
Triphenyltin con	npounds(TPT)				
Asbestos					
Specific azo com	pounds				
Formaldehyde					
Polyvinyl chloric	le (PVC) and PVC blevds				
Beryllium oxide					
Beryllium copp	er				
Specific phthalat	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)				
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)				
Perfluorooctane	sulfonates (PFOS)				
Specific Benzotr	iazole				

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